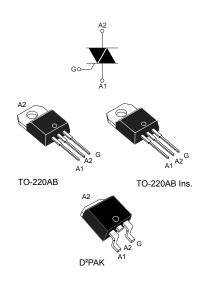


800 V and 600 V, 25 A standard and Snubberless Triacs



Features

- High current 25 A RMS current Triac
- · Low thermal resistance
- High commutation (4 quadrants) or very high commutation (3 quadrants) capability
- BTA series UL1557 recognized components (file ref: 81734)
- RoHS (2002/95/EC) compliant packages
- · UL-94, V0 flammability package resin compliance

Applications

- On/off function in static relays, heating regulation, induction motor starting circuits
- · Phase control operations in light dimmers and motor speed controllers

Description

Available either in through-hole or surface-mount packages, the BTA24, BTB24 and T25 are suitable for general purpose AC switching.



Product status link			
BTA24	TO-220AB insulated package		
BTB24	TO-220AB uninsulated package		
T25	D²PAK package		

Product summary				
	BTA24	BTB24	T25	
I _{T(RMS)}	25 A			
V _{DRM} /V _{RRM}	600 V and 800 V			
I _{GT} Snubberless	35 / 50 mA 35		35 mA	
I _{GT} standard		50 mA		



1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameters			Value	Unit
I _{T(RMS)}	RMS on-state current (full sine wave)	$T_{\rm C} = 100 ^{\circ}{\rm C}$		25	А
		TO-220AB Ins.	T _c = 75 °C		
L	Non repetitive surge peak on-state current (full cycle,	f = 60 Hz	t _p = 16,7 ms	260	
I _{TSM}	T _j initial = 25 °C)	f = 50 Hz	t _p = 20 ms	250	Α
l ² t	I ² t value for fusing	340	A ² s		
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \le 100 \text{ ns}$	f = 120 Hz	T _j = 125 °C	50	A/µs
V _{DSM} , V _{RSM}	Non repetitive surge peak off-state voltage $t_p = 1$		T _j = 25 °C	V _{DRM} , V _{RRM} + 100	V
V_{DRM}, V_{RRM}	Repetitive peak off-state voltage	'	T _j = 25 °C	600 or 800	V
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 125 °C	4	Α
P _{G(AV)}	Average gate power dissipation	T _j = 125 °C	1	W	
T _{stg}	Storage junction temperature range	-40 to +150	°C		
Tj	Operating junction temperature range	-40 to +125	°C		
TL	Maximum lead temperature for soldering during 10 s		260	°C	
V _{INS}	Insulation RMS voltage, 1 minute			2.5	kV

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified) - Snubberless (3 quadrants) T25, BTA24-XXXXW, BTB24-XXXXW

Symbol	Parameters	Quadrant		T25	ВТА	/BTB	Unit
Зуппоп	raidilleters	Quadrant		T2535	cw	BW	Ullit
I _{GT} ⁽¹⁾	V _D = 12 V, R _I = 33 Ω	1 - 11 - 111	Max.	35	35	50	mA
V _{GT}	VD = 12 V, NC = 33 \(\text{2} \)	1 - 11 - 111	Max.		1.3	,	V
V_{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega, T_j = 125 \text{ °C}$			0.2			V
IH ⁽²⁾	I _T = 500 mA			50	50	75	mA
IL	I _G = 1.2 I _{GT}	1 - 111	Max.	70	70	80	mΛ
'L	IG = 1.2 IG	II		80	80	100	mA
dV/dt ⁽²⁾	$V_D = 67 \% V_{DRM}$ gate open, $T_j = 125 \degree C$			500	500	1000	V/µs
(dl/dt)c ⁽²⁾	Without snubber		Min.	13	13	22	A/ms

^{1.} Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.

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^{2.} For both polarities of A2 referenced to A1



Table 3. Electrical characteristics (T_j = 25 °C, unless otherwise specified) - standard (4 quadrants) BTB24-800B, BTB24-600B

Symbol	Parameters	Quadrant		Value	Unit
I _{GT} ⁽¹⁾		1 - 11 - 111	Max.	50	mA
'GT` ′	$V_D = 12 \text{ V}, R_L = 33 \Omega$	IV	IVIAX.	100	IIIA
V_{GT}		All	Max.	1.3	V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$, $T_j = 125 \text{ °C}$		Min.	0.2	V
IH ⁽²⁾	I _T = 500 mA				mA
l _l	I _G = 1.2 I _{GT}	I - III - IV	Max.	70	m 1
"L	IG - 1.2 IGT	II	Max.	160	mA
dV/dt ⁽²⁾	$V_D = 67 \% V_{DRM}$ gate open, $T_j = 125 \degree C$				V/µs
(dV/dt)c ⁽²⁾	$c^{(2)}$ (dl/dt)c = 13.3 A/ms, T_j = 125 °C				V/µs

- 1. Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.
- 2. For both polarities of A2 referenced to A1

Table 4. Static electrical characteristics

Symbol	Test conditions	T _j		Value	Unit
V _{TM} ⁽¹⁾	I_{TM} = 35 A, t_p = 380 μ s 25 °C		Max.	1.55	V
V _{TO} ⁽¹⁾	threshold on-state voltage	125 °C	Max.	0.85	V
R _D ⁽¹⁾	Dynamic resistance	125 °C	Max.	16	mΩ
I _{DRM} /I _{RRM}	$V_T = V_{DRM}, V_T = V_{RRM}$	25 °C	Max.	5	μA
'DRM''RRM	VI - VDRM, VI - VRRM	125 °C	IVIAX.	3	mA

1. For both polarities of A2 referenced to A1

Table 5. Thermal resistance

Symbol	Pa	Value	Unit		
Pa a	Junction to case (AC)		Max.	0.8	
R _{th(j-c)}	Junction to case (AC)	TO-220AB insulated	iviax.	1.7	°C/W
Pa a	Junction to ambient, S ⁽¹⁾ = 2.5 cm ² D ² PAK		Tun	45	C/VV
R _{th(j-a)}	Junction to ambient	TO-220AB / TO-220AB insulated	Тур.	60	

1. S = Copper surface under tab.

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1.1 Characteristics (curves)

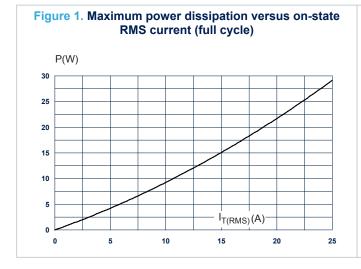


Figure 2. RMS on-state current versus case temperature (full cycle)

IT(RMS) (A)

25

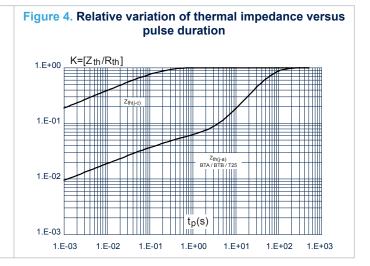
BTB24/T25

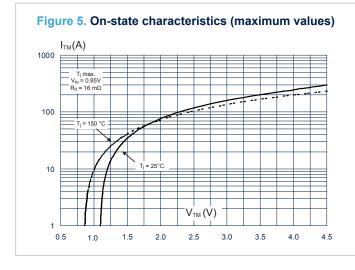
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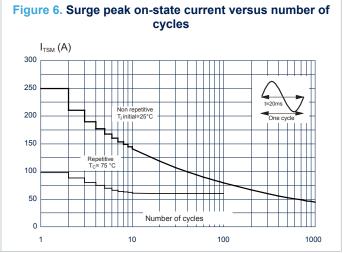
TC (°C)

0 25 50 75 100 125

Figure 3. RMS on-state current versus ambient temperature (full cycle) D2PAK $I_{T(RMS)}(A)$ 4.0 3.5 3.0 2.5 2.0 1.5 1.0 0.5 T_a (°C) 0.0 0 25 50 75 100 125







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Figure 7. Non-repetitive surge peak on-state current for a sinusoidal pulse with width t_P < 10 ms

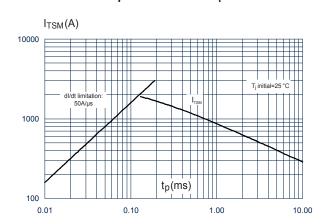


Figure 8. Relative variation of gate trigger current, holding and latching current versus junction temperature

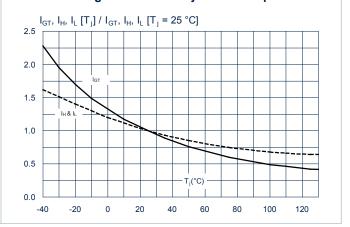


Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

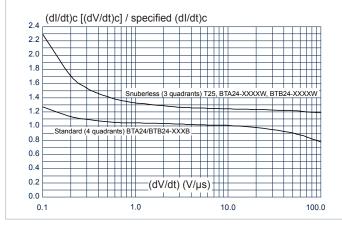


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature (typical values)

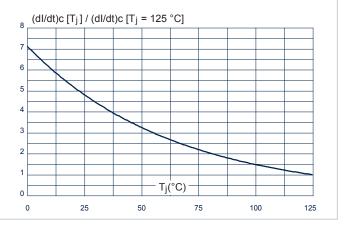
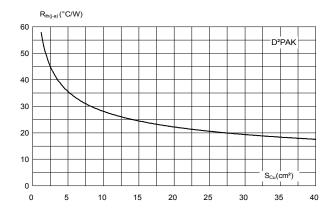


Figure 11. D2PAK thermal resistance junction to ambient versus copper surface under tab



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-220AB package information

- Molding compound resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free plating package leads
- Recommended torque: 0.4 to 0.6 N·m

14

13

12

В b2 Resin gate 0.5 mm max. protusion⁽¹⁾ L

Figure 12. TO-220AB package outline

F c2 с1 Resin gate 0.5 mm max. protusion(1)

Α

a2

а1

b1

(1)Resin gate position accepted in one of the two positions or in the symmetrical opposites.

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Table 6. TO-220AB package mechanical data

			Di	mensions				
Ref.		Millimeters			Inches ⁽¹⁾			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	15.20		15.90	0.5984		0.6260		
a1		3.75			0.1476			
a2	13.00		14.00	0.5118		0.5512		
В	10.00		10.40	0.3937		0.4094		
b1	0.61		0.88	0.0240		0.0346		
b2	1.23		1.32	0.0484		0.0520		
С	4.40		4.60	0.1732		0.1811		
c1	0.49		0.70	0.0193		0.0276		
c2	2.40		2.72	0.0945		0.1071		
е	2.40		2.70	0.0945		0.1063		
F	6.20		6.60	0.2441		0.2598		
I	3.73		3.88	0.1469		0.1528		
L	2.65		2.95	0.1043		0.1161		
12	1.14		1.70	0.0449		0.0669		
13	1.14		1.70	0.0449		0.0669		
14	15.80	16.40	16.80	0.6220	0.6457	0.6614		
М		2.6			0.1024			

^{1.} Inch dimensions are for reference only.

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2.2 D²PAK package information

- ECOPACK2 compliant
- · Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL94 flammability standard level V0

Max resin gate protrusion: 0.5 mm (1)

A1

A2

A3

Gauge Plane

Figure 13. D²PAK package outline

(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

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Table 7. D²PAK package mechanical data

				Dimensions		
Ref.		Millimeters			Inches ⁽¹⁾	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
С	0.45		0.60	0.0177	0.0177	
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
е	2.54			0.10000		
Е	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
Н	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.19		1.40	0.0468		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2 ⁽²⁾	0°		8°	0°		8°

^{1.} Dimensions in inches are given for reference only

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^{2.} Degrees



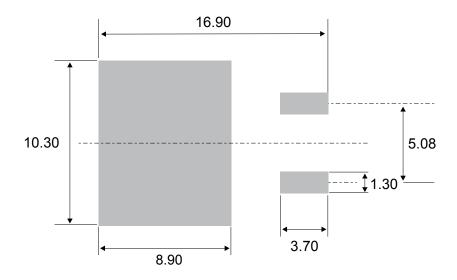
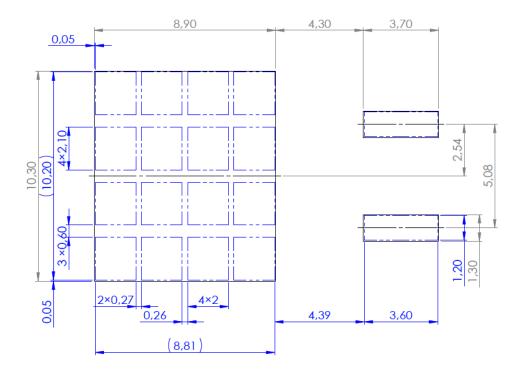


Figure 15. D²PAK stencil definitions (dimensions are in mm)



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3 Ordering information

Figure 16. Ordering information scheme (BTA24 and BTB24 series)

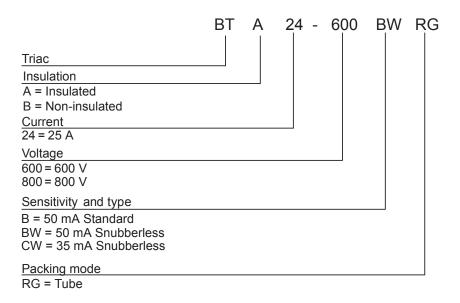
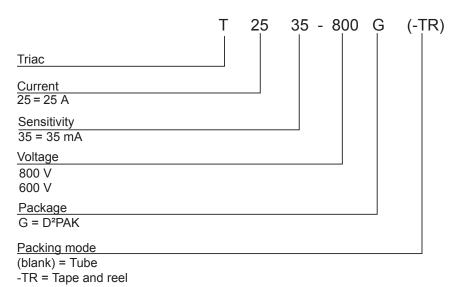


Figure 17. Ordering information scheme (T25 series)



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Table 8. Ordering information

Order code	Order code Marking Package		Weig ht	Base qty.	Delivery mode
BTA24-600BWRG	BTA24 600BW				
BTA24-600CWRG	BTA24 600CW	TO 220AP insulated			
BTA24-800BWRG	BTA24 800BW	TO-220AB insulated			
BTA24-800CWRG	BTA24 800CW				
BTB24-600BRG	BTB24 600B		224	50	Tube
BTB24-600BWRG	BTB24 600BW		2.3 g	50	rube
BTB24-600CWRG	BTB24 600CW	TO-220AB			
BTB24-800BRG	BTB24 800B	10-220AB			
BTB24-800BWRG	BTB24 800BW				
BTB24-800CWRG	BTB24 800CW				
T2535-600G	T2535 600G			50	Tube
T2535-600G-TR	T2535 600G	D²PAK	1.5 g	2500	Tape and reel
T2535-800G	T2535 800G			50	Tube
T2535-800G-TR	T2535 800G			2500	Tape and reel

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Revision history

Table 9. Document revision history

Date	Revision	Changes
Oct-2002	6A	Previous update.
13-Feb-2006	7	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.
31-May-2006	8	Reformatted to current standard. Tc in figure 3 changed to Tamb
31-Jul-2006	9	Typing error corrected on page 1 (BTB124 instead of BTB24)
05-Jul-2007	10	Added BTB26-600BRG. Restructured cover page and section 2: Ordering information scheme on page 6 to simplify product selection. Thermal resistance values updated in Table 6 and Figure 2. Graphic for I2t updated in Figure 7.
28-Jul-2021	11	Removed RD91, TOP3 insulated and TOP3 package information. Put in separate specification. Minor text changes.
29-Sep-2021	12	Updated Table 2.

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